



# 深圳市旭宇光电有限公司

SHENZHEN XUYU OPTOELECTRONICS CO., LTD.

## LED 1W大功率 RGB 产品规格书

(Product specifications 1W RGB High Power LED)

Product Type (产品型号): XY-1W RGB-X

File number (文件编号): XY-11-16-2

Version number (版本编号): 1

Product Description (产品描述):

- 1W High Power LED (LED 1W大功率)
- LED Type: Full color (发光类型: 全彩)
- Lens Color: colorless, transparent (胶体颜色: 无色透明)



### ATTENTION

OBSERVE PRECAUTIONS  
ELECTROSTATIC  
SENSITIVE DEVICES

编制: 李金边

审核: 林金填

核准:

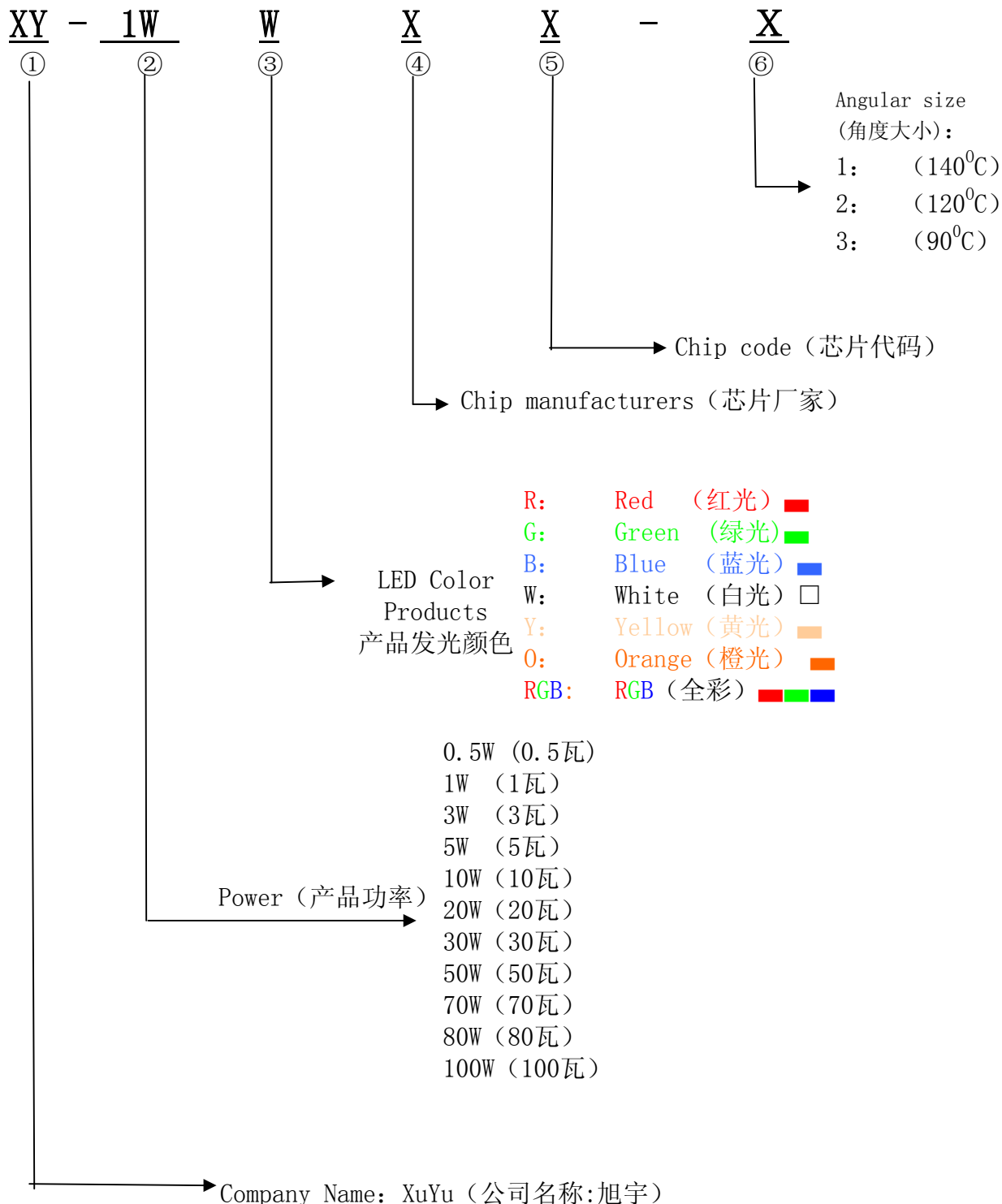


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型号 (Model) :	XY-1W RGB-X
文件编号 (File number) :	XY-11-16-2
版本编号 (Version number) :	1

## ◆Product Naming (产品命名规则)

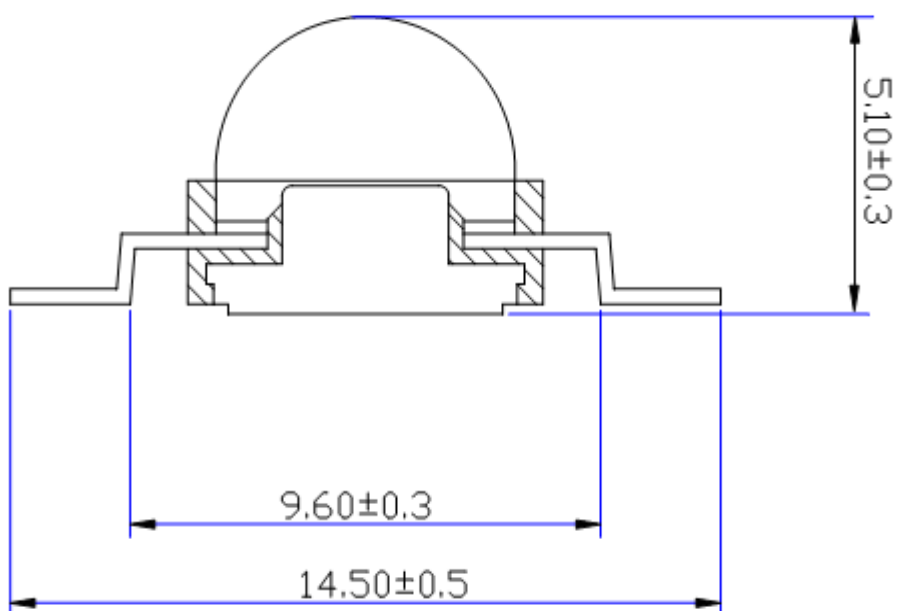
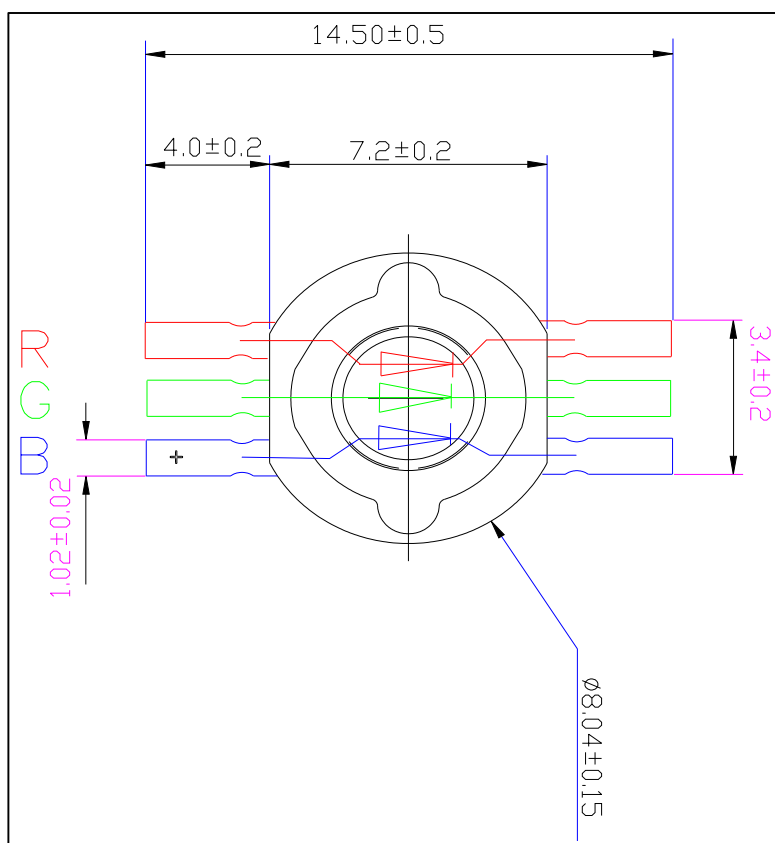




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## ◆Package Dimensions (外观尺寸)





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## ◆The main optical and electrical properties (主要光电特性) (Ta=25°C)

Project (项目)	Symbol (符号)	Conditions (条件)	Min. (最小值)	Average (平均值)	Max. (最大值)	Units (单位)
Forward Voltage (正向电压)	VF	IF=350mA	R:2.0 G:3.0 B:3.0		R:2.6 G:3.6 B:3.6	V
Reverse current (反向电流)	IR	VR=5V	0		10	μA
Flux (光通量)	Φ	IF=350mA	R:40 G:75 B:25		R:45 G:80 B:30	Lm
Dominant Wavelength (主波长)	λd	IF=350mA	R:620 G:517 B:460		R:630 G:525 B:470	nm

## ◆Absolute Maximum Rating Ta=25°C) 极限参数值

Project (项目)	Symbol (符号)	Limit parameter (极限参数)	Units (单位)	
Forward Current (正向电流)	IF	350	mA	
Recommended Current (推荐工作电流)	IF	≤350	mA	
Pulse peak current (脉冲峰值电流)	IFP	1000	mA	
Reverse Voltage (反向电压)	VR	5	V	
Power (功耗)	PD	1	W	
Operating temperature (工作温度)	Topr	(-20~+60)	°C	
Storage Temperature (贮藏温度)	Tstg	(-40~+80)	°C	
Hand soldering temperature (手工焊接温度)	Tstg	350°C/3秒钟 (Seconds)		
ESD Sensitivity (抗静电级别)	ESD	2000V HBM		

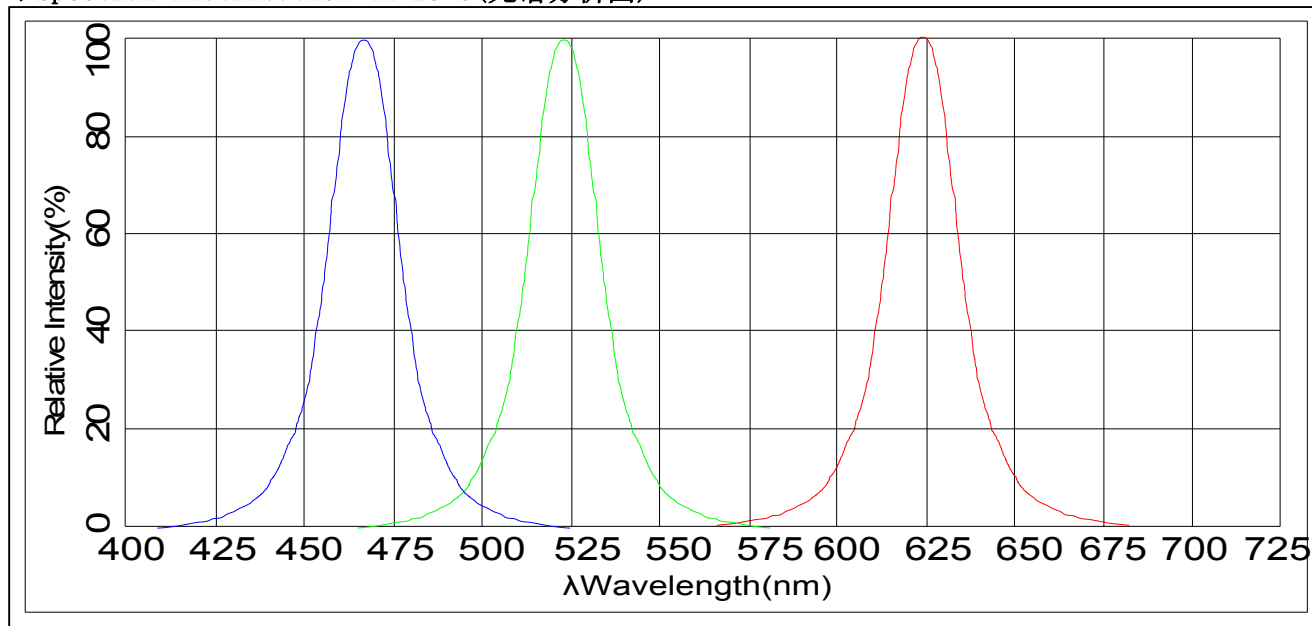
\*脉冲宽度 (Pulse width) ≤ 0.1msec 占空比 (Duty Cycle) ≤ 1/10



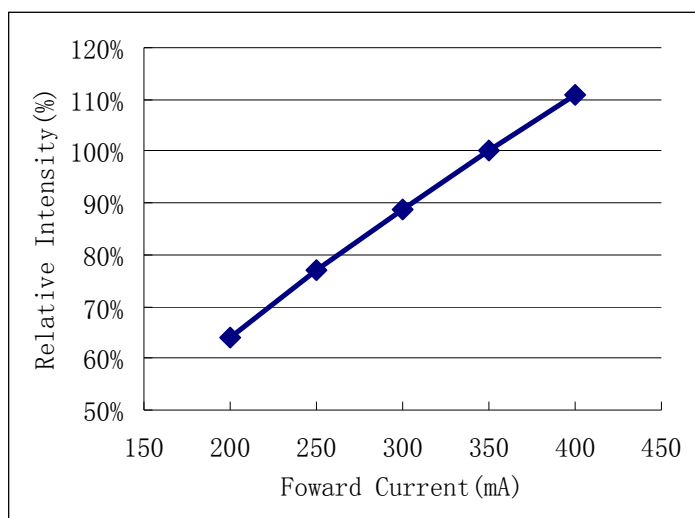
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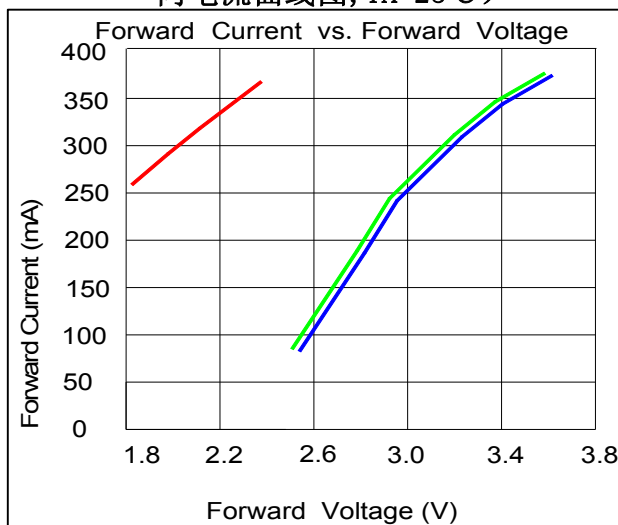
## ◆ Spectrum Distribution TA=25°C (光谱分析图)



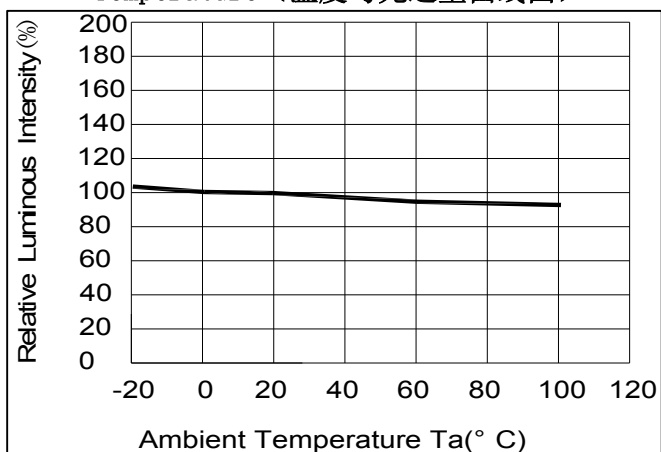
## ◆ Typical Dome Type Radiation pattern (正向电流和相对流明度)



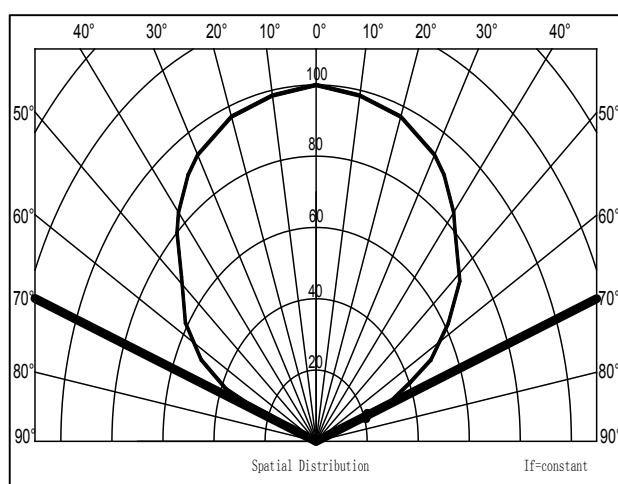
## ◆ Forward voltage and forward current curves (正向电压和正向电流曲线图, TA=25°C)



## ◆ Relative Luminous Intensity VS Ambient Temperature (温度与光通量曲线图)



## ◆ Radiation Diagram (角度图)





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## ◆Reliability Test Standards (可靠性试验标准)

### ●Pilot project (试验项目)

Type (类型)	Pilot project (试验项目)	Test conditions (试验条件)	Duration (持续时间)	The number of samples (取样数)	Charge level (收取水准)
Environmental testing (环境实验)	Temperature cycling (温度循环)	-45°C(30Minutes) ~25°C(5Minutes)~ 100°C(30Minutes)~ 25°C(5Minutes)	Cycle 100 Round (循环100回合)	30	0/30
	Thermal Shock (冷热冲击)	-40°C(15Minutes) ~ 100°C(15Minutes)	Cycle 300 Round (循环300回合)	30	0/30
	Humidity cycle (高湿循环)	30°C~65°C RH=90% 24H/1Round	Cycle 50 Round (循环50回合)	30	0/30
	High Temperature Storage (高温储存)	T <sub>a</sub> =100°C	1000H	30	0/30
	Cryogenic storage (低温储存)	T <sub>a</sub> =-40°C	1000H	30	0/30
	High temperature and humidity storage (高温高湿储存)	T <sub>a</sub> =60°C RH=90%	1000H	30	0/30
Life test (寿命实验)	Life test at room temperature (常温寿命)	T <sub>a</sub> =25°C I <sub>F</sub> =350mA	1000H	30	0/30
	High temperature and humidity life test (高温高湿寿命实验)	T <sub>a</sub> =60°C RH=90% I <sub>F</sub> =350mA	1000H	30	0/30
	Low-temperature life test (低温寿命实验)	T <sub>a</sub> =-30°C I <sub>F</sub> =350mA	1000H	30	0/30
Destructive test (破坏性实验)	Resistance to soldering heat (耐焊性)	T <sub>sol</sub> =360°C±5°C, 10S	Welding time 焊接一次	5	0/5
	Solderability (可焊性: 手工焊)	T <sub>sol</sub> =350°C±5°C, 5S Using flux (使用助焊剂)	Welding time 焊接一次	5	0/5
Mechanical test (机械实验)	Vibration test (振动实验)	20G 20-2000HZ 4Min X, Y, Z	Loop 4 times in each direction (每个方向循环4次)	5	0/5
	Drop test (跌落实验)	75mm	Cycle 3 Round (3次)	5	0/5

### ●判定标准 (Criteria of)

Project (项目)	Marked (标示)	Test Conditions (测试条件)	Criteria (判断标准)
Forward Voltage (正向电压)	V <sub>F</sub>	I <sub>F</sub> =350mA	Initial value ±10% (初始值)
(Reverse current) 反向电流	I <sub>R</sub>	V <sub>R</sub> =5V	≤10 μA
Flux (光通量)	Φ <sub>V</sub>	I <sub>F</sub> =350mA	Error (误差) ≤5%, And the average attenuation (并且平均衰减) ≤3%
Solderability (可焊性)			Baptist Yi area of more than 95% (浸锡面积达95%以上)
Vibration test (振动实验)		I <sub>F</sub> =350mA	Significant damage to the lights and not dead (没有死灯及明显损坏)
Drop test (跌落实验)		I <sub>F</sub> =350mA	

Remarks (备注): RH: Humidity (环境湿度); Ta: Ambient temperature (环境温度);

Tsol: Tin liquid temperature (锡液温度); IF: Forward Current (正向电流); VR: Reverse Voltage (反向电压) 6/6